

- ( ) Preliminary Specifications(✓ ) Final Specifications

Module 15.6" (15.55) FHD 16:9 Color TFT-LCD with LED Backlight design				
Model Name	B156HAK01.0 (H/W:0A)			
Note ( 🗭 )	o-TP Display			

Customer	Date					
Checked & Approved by	Date					
Note: This Specification is subject to change without notice.						

Approved by	Date			
Buffy Chen	2016/03/10			
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## **Record of Revision**

Vei	Version and Date Page		Old description	New Description	Remark
0.1	2015/09/30	All	First Edition for Customer		
0.2	2015/11/16	P.20,27,28, 29,32		Updated Connector Description, LCM Outline Dimension, Shipping Label and EDID	
0.3	2016/01/20	P.29	Label CT NO. old format	Use "Ø" to Zero in the CT no. format	
1.0	2016/03/10	P. 6	TP F/W version: TBD	TP F/W version: 00-T5	
		P. 7	Color / Chromaticity Coodinates: TBD	Color / Chromaticity Coodinates: UPDATE	
		P. 18		ADD Touch Sensor Power Consumption	
		P. 26		ADD Touch Panel Power on Sequence	



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### 1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electronic breakdown.



### 2. General Description

B156HAK01.0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 FHD, 1920(H) x 1080(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are eDP(Embedded DisplayPort) interface compatible.

B156HAK01.0 is designed for a display unit of notebook style personal computer and industrial machine.

#### 2.1 General Specification

The following items are characteristics summary on the table at 25  $^{\circ}$ C condition:

Items	Unit	Specification	ons		
Screen Diagonal	[mm]	394.9			
Active Area	[mm]	344.16 x 193	3.59		
Pixels H x V		1920 x 3(RG	B) x 1080		
Pixel Pitch	[mm]	0.17925 x 0.	17925		
Pixel Format		R.G.B. Verti	cal Stripe		
Display Mode		Normally Blo	ack		
White Luminance (ILED= 23 mA) (Note: ILED is LED current)	[cd/m <sup>2</sup> ]			age) (Total Sc age) (Total Sc	
Luminance Uniformity		1.25 max. (5	5 points)		
Contrast Ratio		800:1 typ			
Response Time	[ms]	25 Tvp			
Nominal Input Voltage VDD	[Volt]	+3.3 typ.			
Power Consumption	[Watt]	4.4W			
Weight	[Grams]	370 max.			
Physical Size		Length	Min. 359.00	Typ. 359.50	Max. 360.00
Include bracket					
	[mm]	Width	223.30	223.80	224.30
Thicknessss		Thicknessss	3.2 (Panel 3.4 (PCB s		
Electrical Interface		2 Lane eDP	•		
Glass Thickness	[mm]	0.4			
Surface Treatment		Glare			
Support Color		262K colors	( RGB 6-bit	1	
Temperature Range Operating Storage (Non-Operating)	[°C]	0 to +50 -20 to +60			
RoHS Compliance		RoHS Comp	oliance		



## 2.1.1 General Touch Specification

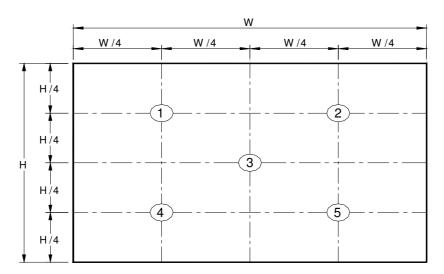
Item	Spec	Unit
Type of Touch Sensor	Projective Capacitive (on cell)	
Panel Size	15.6''	
Outline Dimension	NA(cover lens free)	mm
Total Thickness	NA(cover lens free)	mm
Total Weight	NA(cover lens free)	g
TP View Area	NA(cover lens free)	mm
TP Active Area	346.36 x 195.79	mm
Interface	USB or I2C	
Report Rate	>100	Hz
Multi-Touch Point	10 points	
Input method	Finger	
Touch panel sensor IC	EETi (EXC3104)	
Channel	82(Rx) x 46(Tx)	
Distance between 2 point	TBD	mm
Surface treatment	NA	
TP F/W version	00-T5	
Support OS	Window 8 / Window 10	
BM ink	NA	
TP Power Consumption	300	mW



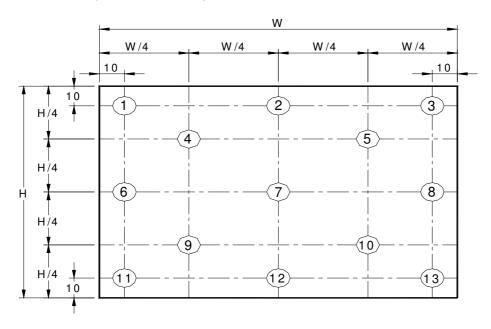
## 2.2 Optical Characteristics

Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Note
White Luminance ILED=21mA			5 points average	187	220	-	cd/m²	1, 4, 5.
Viewing Angle		Θ <sub>R</sub> ΘL	Horizontal (Right) CR = 10 (Left)	80 80	85 85	-	degree	
Viewing Ai	igi <del>c</del>	Ψн Ψι	Vertical (Upper) CR = 10 (Lower)	80 80	85 85	-		4, 9
Luminance Un	iformity	$\delta_{5P}$	5 Points	-	-	1.25		1, 3, 4
Luminance Un	iformity	δ <sub>13P</sub>	13 Points	-	-	1.60		2, 3, 4
Contrast Ro	atio	CR		-	800	-		4, 6
Cross tal	k	%				4		4, 7
Response T	ime	T <sub>RT</sub>	Rising + Falling	-	25	35		
	Red	Rx		0.544	0.574	0.604		
		Ry		0.314	0.344	0.374		
Color /		Gx		0.317	0.347	0.377		
Chromaticity		Gy	CIE 1931	0.538	0.568	0.598		4
Coodinates		Bx		0.130	0.160	0.190		4
	Blue	Ву		0.099	0.129	0.159		
		Wx		0.283	0.313	0.343		
	White	Wy		0.299	0.329	0.359		
NTSC		%		-	45	-		

Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



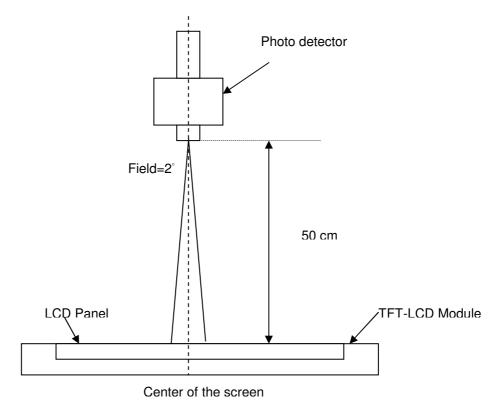
Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

δ <sub>W5</sub> =	Maximum Brightness of five points	
	= '	Minimum Brightness of five points
2	6	Maximum Brightness of thirteen points
$\delta_{W13} =$	=	Minimum Brightness of thirteen points

#### Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the





**Note 5**: Definition of Average Luminance of White (Y<sub>L</sub>):

Measure the luminance of gray level 63 at 5 points  $\cdot$   $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Contrast ratio (CR)= <u>Brightness on the "White" state</u>

Brightness on the "Black" state

Note 7: Definition of Cross Talk (CT)

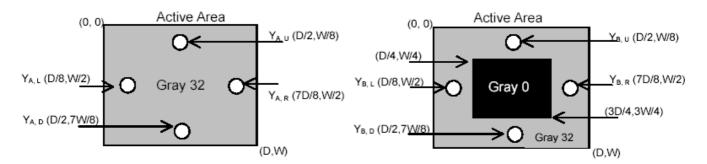
$$CT = | YB - YA | / YA \times 100 (\%)$$

Where

YA = Luminance of measured location without gray level 0 pattern (cd/m2)

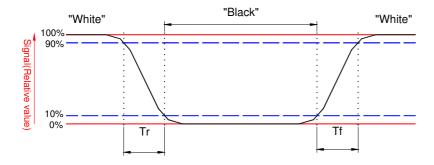
YB = Luminance of measured location with gray level 0 pattern (cd/m2)





Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

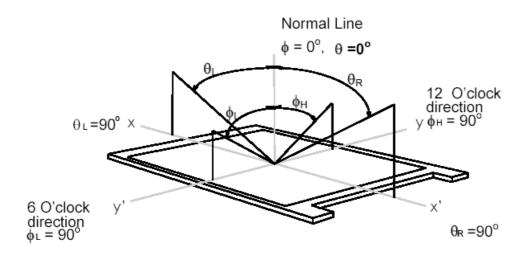




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#### Note 9. Definition of viewing angle

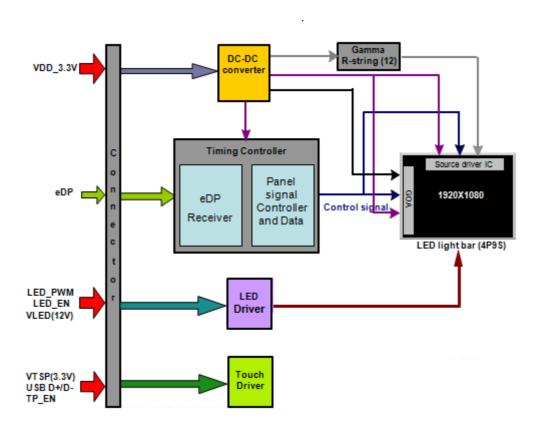
Viewing angle is the measurement of contrast ratio  $\geq$  10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° ( $\theta$ ) horizontal left and right and 90° ( $\Phi$ ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





### 3. Functional Block Diagram

The following diagram shows the functional block of the 15.6 inches wide Color TFT/LCD 40 Pin (One CH/connector Module)





### 4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.1.2 Absolute Ratings of Touch Sensor Module

The Autorian Rainings of Toodin Control Modella								
Item	Symbol	Min	Max	Unit	Conditions			
Touch Sensor Module Power Voltage	VTSP	-0.3	+4.0	[Volt]				
Touch Sensor Module Reset Signal	RST	-0.3	3.6	[Volt]				
Touch Sensor Module enable Signal	TP_EN	-0.3	3.6	[Volt]				

4.2 Absolute Ratings of Environment

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Item	Symbol	Min	Max	Unit	Conditions			
Operating	TOP	0	+50	[°C]	Note 4			
Operation Humidity	НОР	5	95	[%RH]	Note 4			
Storage Temperature	TST	-20	+60	[°C]	Note 4			
Storage Humidity	HST	5	95	[%RH]	Note 4			

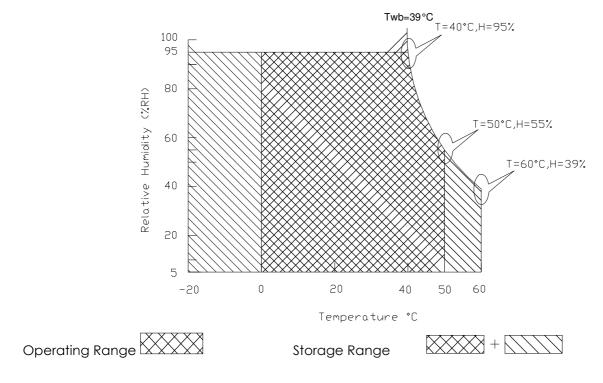
Note 1: At Ta (25°€)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).







#### 5. Electrical Characteristics

### 5.1 TFT LCD Module

### **5.1.1 Power Specification**

Input power specifications are as follows;

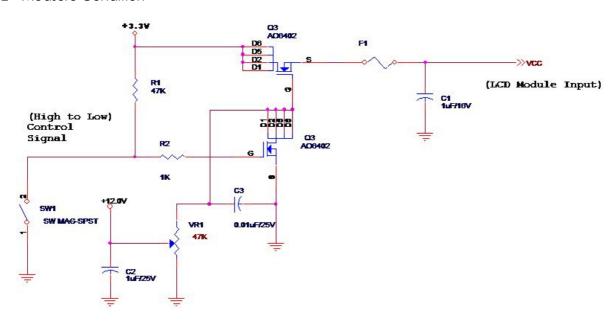
The power specification are measured under  $25^{\circ}$ C and frame frenquency under 60Hz

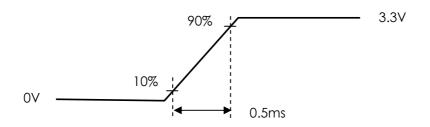
Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	1.2	[Watt]	Note 1
IDD	IDD Current	-	-	400	[mA]	Note 1
IRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern at 3.3V driving voltage. (Pmax=V3.3 x lblack)

Typical Measurement Condition: Mosaic Pattern

Note 2: Measure Condition

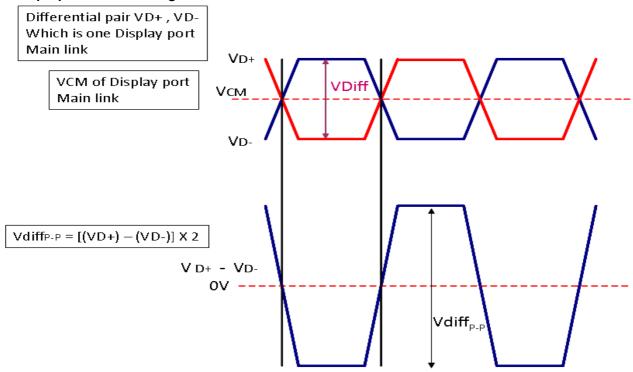




## **5.1.2 Signal Electrical Characteristics**

Signal electrical characteristics are as follows;

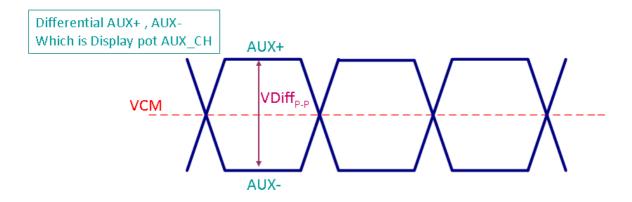
## Display Port main link signal:



	Display port main link				
		Min	Тур	Max	unit
VCM	RX input DC Common Mode Voltage		0		V
VDiff <sub>P-P</sub>	Peak-to-peak Voltage at a receiving Device	100		1320	mV

Follow as VESA display port standard V1.1a

### Display Port AUX\_CH signal:





	Display port AUX_CH										
		Min	Тур	Max	unit						
VCM	AUX DC Common Mode Voltage		0		V						
VDiff <sub>P-P</sub>	AUX Peak-to-peak Voltage at a receiving Device	0.4	0.6	0.8	٧						

Follow as VESA display port standard V1.1a.

## Display Port VHPD signal:

	Display port VHPD										
		Min	Тур	Max	unit						
VHPD	HPD Voltage	2.25	ı	3.6	٧						

Follow as VESA display port standard V1.1a.



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## 5.2 Backlight Unit

### 5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	3.2	[Watt]	(Ta=25°C), Note 1 Vin =12V
LED Life-Time	N/A	15,000	-	-	Hour	(Ta=25°C), Note 2 I <sub>F</sub> =23 mA

Note 1: Calculator value for reference PLED = VF (Normal Distribution) \* IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

#### 5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED	5.0	12.0	21.0	[Volt]	
LED Enable Input High Level	VLED_EN	2.5	-	5.5	[Volt]	
LED Enable Input Low Level	*Note 1	-	-	0.5	[Volt]	
PWM Logic Input High Level	VPWM_EN	2.5	-	5.5	[Volt]	Define as
PWM Logic Input Low Level	*Note 1	-	-	0.5	[Volt]	Connector
PWM Input Frequency	FPWM	200	1K	10K	Hz	(Ta=25°C)
PWM Duty Ratio	Duty	5		100	%	

Note 1: Recommend system pull up/down resistor no bigger than 10kohm



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## **5.3 Touch Sensor Power Consumption**

Items	Symbol	Sp	pecification	Unit	Notes		
liellis	Symbol	Min.	Min. Typ.		Oilli	Noies	
Touch sensor module	VTSP		3	3.3	3.6	V	
Power Supply	V 131		3	0.5	0.0	<b>,</b>	
Touch Sensor Module Power ripple	VTSPrp	-	-	100	mV		
Input Voltage	RST, TP_EN	VIH	2.9		3.3	٧	
inpor vollage	K31, II _LIV	VIL	0		0.4	٧	



### 6. Signal Interface Characteristic

### 6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

		1																		19	20	)
1st Line	R	G	В	R	G	В			-	-			-	-	-	- <del>-</del>	R	G	В	R	G	В
					1							1						1			1	
					•													·				
		'			1							1						'			'	
1080th Line	R	G	В	R	G	В	-	-	-		-	-			-	-	R	G	В	R	G	В



### **6.2 Integration Interface Requirement**

## **6.2.1 Connector Description**

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	STM or compatible
Type / Part Number	STM MSAK24025P40 or compatible
Mating Housing/Part Number	STM PK24025P40 or compatible

### 6.2.2 Pin Assignment

eDP lane is a differential signal technology for LCD interface and high speed data transfer device.

PIN NO	Symbol	Function
1	NC	No Connect
2	H_GND	High Speed Ground
3	Lane1_N	Complement signal link lane 1
4	Lane1_P	True signal link lane 1
5	H_GND	High Speed Ground
6	Lane0_N	Comp Signal Link Lane 0
7	Lane0_P	True Signal Link Lane 0
8	H_GND	High Speed Ground
9	AUX_CH_P	True Signal Auxiliary Ch.
10	AUX_CH_N	Comp Signal Auxiliary Ch.
11	H_GND	High Speed Ground
12	LCD_VCC	LCD logic and driver power
13	LCD_VCC	LCD logic and driver power
14	LCD_Self_Test	LCD Panel Self Test Enable
15	LCD GND	LCD logic and driver ground
16	LCD GND	LCD logic and driver ground
17	HPD	HPD signale pin
18	BL_GND	Backlight_ground
19	BL_GND	Backlight_ground
20	BL_GND	Backlight_ground
21	BL_GND	Backlight_ground



22	BL_Enable	Backlight On / Off
23	BL PWM DIM	System PWM signal Input
24	NC	No connect (Reverse for AUO TEST only)
25	NC	No connect (Reverse for AUO TEST only)
26	BL_PWR	Backlight power
27	BL_PWR	Backlight power
28	BL_PWR	Backlight power
29	BL_PWR	Backlight power
30	NC	No Connect (Reserved for CM)
31	TP_D-	USB Data- for Touch
32	TP_D+	USB Data+ for Touch
33	GND	Ground-Shield
34	VTSP	Touch panel power supply (3.3V)
35	VTSP	Touch panel power supply (3.3V)
36	TP_EN	TP Enable (active high)
37	TP_CLK	I2C Clock for Touch (NC for USB input)
38	TP_Data	I2C Data for Touch (NC for USB input)
39	INT	Interrupt for Touch (NC for USB input)
40	RST	Reset for Touch (NC for USB input)

Note1: start from right side

Note2: Input signals shall be low or High-impedance state when VDD is off.



### **6.3 Interface Timing**

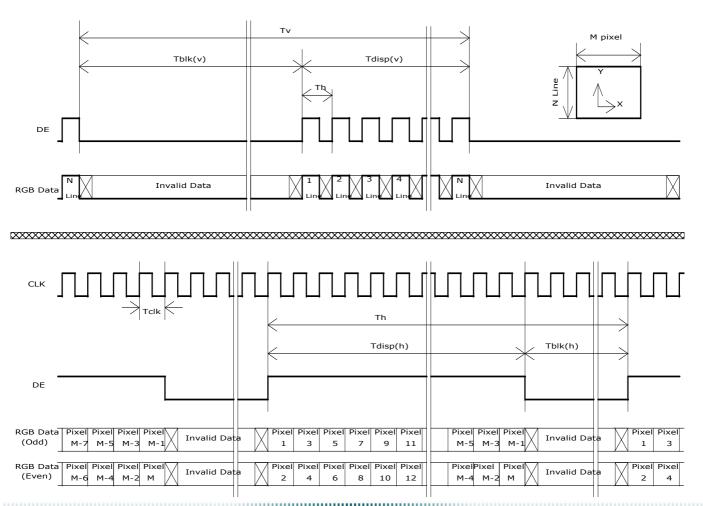
Basically, interface timings should match the 1920x1080 /60Hz manufacturing guide line timing.

Parar	neter	Symbol	Min.	Тур.	Max.	Unit			
Frame	e Rate	-	-	60	-	Hz			
Clock fre	equency	1/ T <sub>Clock</sub>	•	141	•	MHz			
	Period	T <sub>V</sub>	1084	1116	3080				
Vertical	Active	<b>T</b> VD			<b>T</b> Line				
Section	Blanking	T∨B	4	36	2000				
	Period	T <sub>H</sub>	2000	2104	2320				
Horizontal	Active	<b>T</b> HD		1920					
Section	Blanking	Тнв	80	184	400				

Note: 1. DE mode only

2. The maximum clock frequency = (1920+B)\*(1080+A)\*60 < 149.1MHz

### 6.3.2 Timing diagram



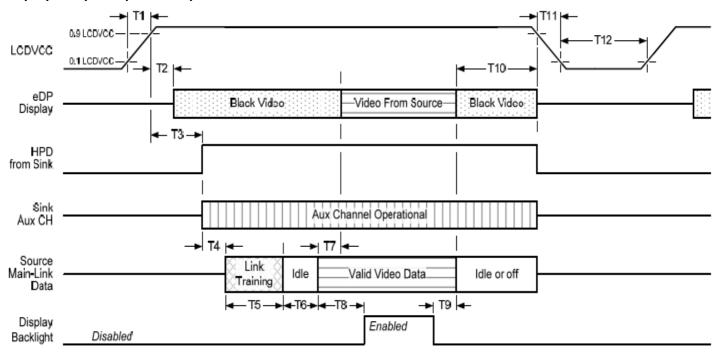


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#### 6.4 Power ON/OFF Sequence

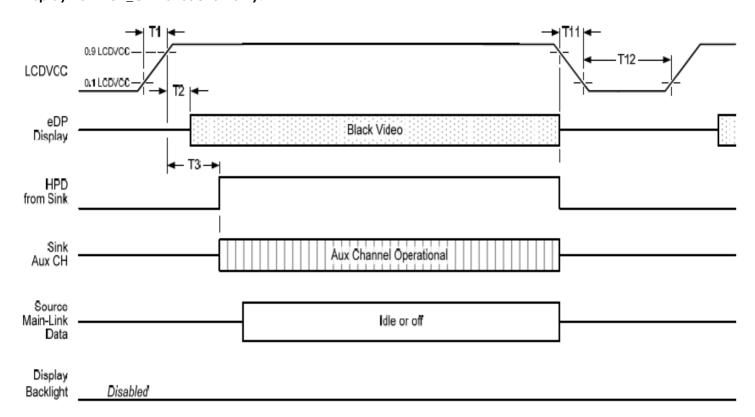
Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off

## Display Port panel power sequence:



### Display port interface power up/down sequence, normal system operation

### Display Port AUX\_CH transaction only:



Display port interface power up/down sequence, AUX\_CH transaction only



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Display Port panel power sequence timing parameter:

Timing	Description	Reqd. by	Limits			Notes
parameter			Min.	Тур.	Max.	Notes
T1	power rail rise time, 10% to 90%	source	0.5ms		10ms	
Т2	delay from LCDVDD to black video generation	sink	0ms		200ms	prevents display noise until valid video data is received from the source
Т3	delay from LCDVDD to HPD high	sink	0ms		200ms	sink AUX_CH must be operational upon HPD high.
T4	delay from HPD high to link training initialization	source				allows for source to read link capability and initialize.
Т5	link training duration	source				dependant on source link to read training protocol.
Т6	link idle	source				Min accounts for required BS-Idle pattern. Max allows for source frame synchronization.
<b>T7</b>	delay from valid video data from source to video on display	sink	0ms		50ms	max allows sink validate video data and timing.
Т8	delay from valid video data from source to backlight enable	source				source must assure display video is stable.
Т9	delay from backlight disable to end of valid video data	source				source must assure backlight is no longer illuminated.
T10	delay from end of valid video data from source to power off	source	0ms		500ms	
T11	power rail fall time, 905 to 10%	source			10ms	
T12	power off time	source	500ms			

**Note1:** The sink must include the ability to generate black video autonomously. The sink must automatically enable black video under the following conditions:

-upon LCDVDD power on (with in T2 max)-when the "Novideostream\_Flag" (VB-ID Bit 3) is received from the source (at the end of T9).

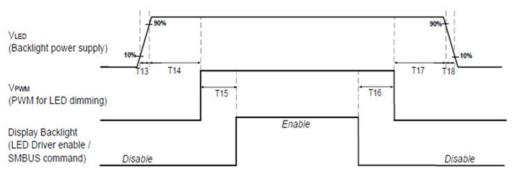
-when no main link data, or invalid video data, is received from the source. Black video must be displayed within 64ms (typ) from the start of either condition. Video data can be deemed invalid based on MSA and timing information, for example.

**Note 2:** The sink may implement the ability to disable the black video function, as described in Note 1, above, for system development and debugging purpose.

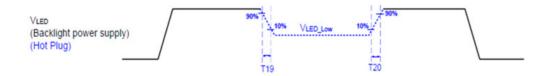
**Note 3:** The sink must support AUX\_CH polling by the source immediately following LCDVDD power on without causing damage to the sink device (the source can re-try if the sink is not ready). The sink must be able to respond to an AUX\_CH transaction with the time specified within T3 max.



## Display Port panel B/L power sequence timing parameter:



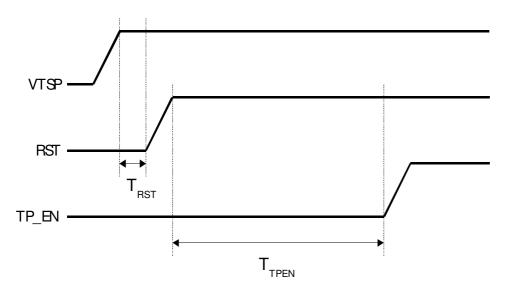
Note: When the adapter is hot plugged, the backlight power supply sequence is shown as below.



	Min (ms)	Max (ms)
T13	0.5	10
T14	10	-
T15	10	-
T16	10	-
T17	10	-
T18	0.5	10
T19	1*	-
T20	1*	-

Seamless change: T19/T20 = 5xT<sub>PWM</sub>\*

## **Touch Panel Power on Sequence**



Timing	Description	Min (ms)
T <sub>RST</sub>	signal delay time from VTSP (TP power)	1
T <sub>TPEN</sub>	able signal delay time from reset signal	20

<sup>\*</sup>T<sub>PWM</sub>= 1/PWM Frequency



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### 7. Panel Reliability Test

#### 7.1 Vibration Test

### **Test Spec:**

Test method: Non-Operation

1.5 G Acceleration:

Frequency: 10 - 500Hz Random

30 Minutes each Axis (X, Y, Z) Sweep:

#### 7.2 Shock Test

#### **Test Spec:**

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

### 7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta=0℃, 300h	
High Temperature Storage	Ta= 60℃, 300h	
Low Temperature Storage	Ta= -20℃, 250h	
Thermal Shock Test	Ta=-20 $^{\circ}$ (30min) ~60 $^{\circ}$ (30min), 100cycles condition.	
ESD	Contact : ±8 KV	Note 1
	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

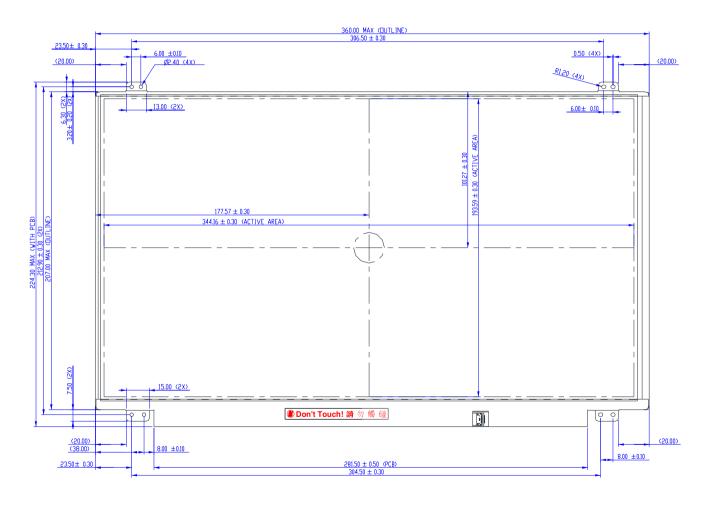
. Self-recoverable. No hardware failures.

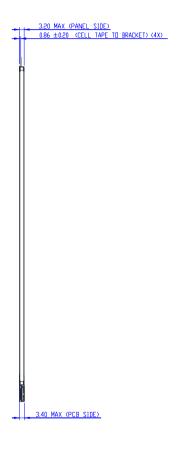
Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



## AU OPTRONICS CORPORATION

- 8. Mechanical Characteristics
- 8.1 LCM Outline Dimension
- 8.1.1 Standard Front View

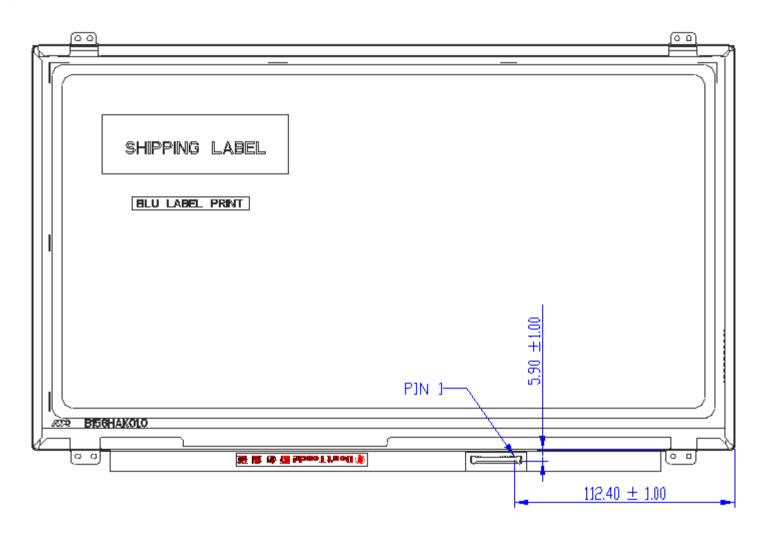






AU OPTRONICS CORPORATION

#### 8.1.2 Standard Rear View



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- 9. Shipping and Package
- 9.1 Shipping Label Format



Manufactured MM/WW Model No: B156HAKØ1.Ø All Optronics MADE IN CHINA (\$01) H/W: 0A F/W:1

c 71 US Pb

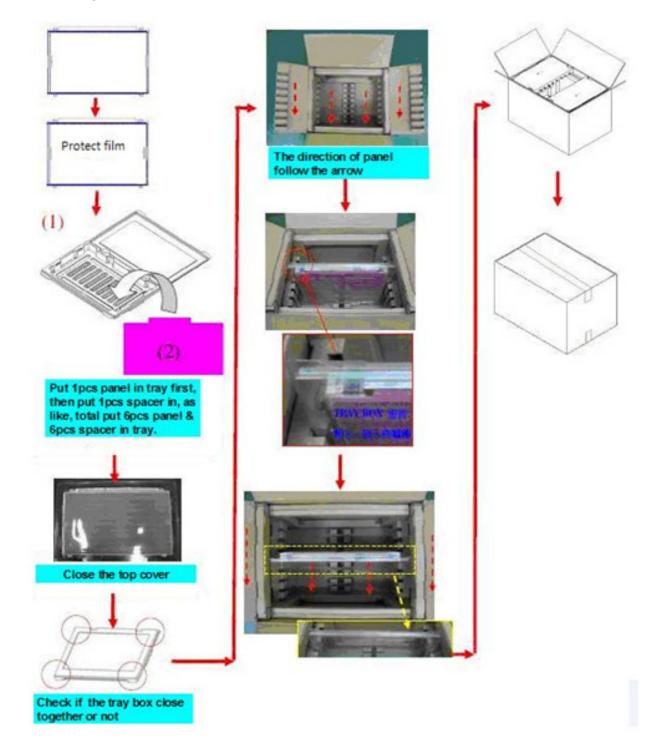






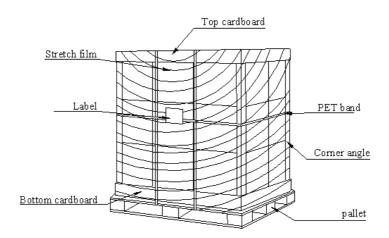


### 9.2 Carton Package





### 9.3 Shipping Package of Palletizing Sequence





10. Appendix: EDID Description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	111111111	255	
02		FF	111111111	255	
03		FF	111111111	255	
04		FF	111111111	255	
05		FF	111111111	255	
06		FF	111111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	ED	11101101	237	
ОВ	hex, LSB first	10	00010000	16	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
OF		00	00000000	0	
10	Week of manufacture	00	00000000	0	
11	Year of manufacture	19	00011001	25	
12	EDID Structure Ver.	01	0000001	1	
13	EDID revision #	04	00000100	4	
14	Video input def. (digital I/P, non-TMDS, CRGB)	95	10010101	149	
15	Max H image size (rounded to cm)	22	00100010	34	
16	Max V image size (rounded to cm)	13	00010011	19	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
	Feature support (no DPMS, Active OFF, RGB, tmg				
18	BIK#1)	02	00000010	2	
19	Red/green low bits (Lower 2:2:2:2 bits)	2E	00101110	46	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	8E	10001110	142	
1B	Red x (Upper 8 bits)	95	10010101	149	
1C	Red y/ highER 8 bits	58	01011000	88	
1D	Green x	59	01011001	89	
1E	Green y	93	10010011	147	
1F	Blue x	29	00101001	41	
20	Blue y	25	00100101	37	
21	White x	53	01010011	83	
22	White y	5A	01011010	90	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27	Characterist Ho	01	00000001	1	
28	Standard timing #2	01	00000001	1	
29		01	00000001	I	



.—					•
2A	Standard timing #3	01	00000001	1	
2B		01	00000001	1	
2C	Standard timing #4	01	00000001	1	
2D	ordinadra mining ii i	01	00000001	1	
2E	Standard timing #5	01	00000001	1	
2F	Statidata littiilig #3	01	00000001	1	
30	Standard timing #6	01	00000001	1	
	Statidata littiitig #6			1	
31	Characteristics of 117	01	00000001	1	
32	Standard timing #7	01	00000001	1	
33	01 1 11 1 10	01	00000001	1	
34	Standard timing #8	01	00000001	ı	
35		01	00000001	1	
36	Pixel Clock/10000 LSB	14	00010100	20	
37	Pixel Clock/10000 USB	37	00110111	55	
38	Horz active Lower 8bits	80	10000000	128	
39	Horz blanking Lower 8bits	B4	10110100	180	
3A	HorzAct:HorzBlnk Upper 4:4 bits	70	01110000	112	
3B	Vertical Active Lower 8bits	38	00111000	56	
3C	Vertical Blanking Lower 8bits	26	00100110	38	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	40	01000000	64	
3E	HorzSync. Offset	6C	01101100	108	
3F	HorzSync.Width	30	00110000	48	
40	VertSync.Offset: VertSync.Width	AA	10101010	170	
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	58	01011000	88	
43	Vertical Image Size Lower 8bits	C1	11000001	193	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16	
45	Horizontal Border (zero for internal LCD)	00	00000000	0	
46	Vertical Border (zero for internal LCD)	00	00000000	0	
	Signal (non-intr, norm, no stero, sep sync, neg pol)				
47	Pixel Clock/10,000 (LSB)	18	00011000	24	
48		B8	10111000	184	
49	Pixel Clock/10,000 (MSB)	24	00100100	36	40Hz frame rate
4A	Horizontal Addressable Pixels, lower 8 bits	80	10000000	128	
4B	Horizontal Blanking Pixels, lower 8 bits	B4	10110100	180	
4C	H Pixels, upper nibble : H Blanking, upper nibble	70	01110000	112	
4D	Vertical Addressable Lines, lower 8 bits	38	00111000	56	
4E	Vertical Blanking Lines, lower 8 bits	26	00100110	38	
4F	V lines, upper nibble : V blanking, upper nibble	40	01000000	64	
50	Horizontal Front Porch, lower 8 bits	6C	01101100	108	
51	Horizontal Sync Pulse, lower 8 bits	30	00110000	48	
52	V Front Porch, lower nibble : V Sync Pulse, lower nibble	AA	10101010	170	
53	VFP, 2 bits: VSP 2 bits: HFP 2 bits: HFP 2 bits	00	00000000	0	
54	Horizontal Image Size in mm, lower 8 bits	58	01011000	88	
55	Vertical Image Size in mm, lower 8 bits	C1	11000001	193	
56	H Image Size, upper nibble : V Image Size, upper nibble	10	00010000	16	
57	Horizontal Border	00	00000000	0	
58	Vertical Border	00	00000000	0	



59	Bit Encode Sync Information	18	00011000	24	
5A	DC	00	00000000	0	
5B	HTOTAL	00	00000000	0	
5C	НА	00	00000000	0	
5D	HBL	00	00000000	0	
5E	HFP	00	00000000	0	
5F	HFPe	00	00000000	0	
60	НВР	00	00000000	0	
61	НВ	00	00000000	0	
62	HSO	00	00000000	0	nVDPS
63	HS	00	00000000	0	Reserved 00
64	VTOTAL	00	00000000	0	
65	VA	00	00000000	0	
66	VBL	00	00000000	0	
67	VFP	00	00000000	0	
68	VBP	00	00000000	0	
69	VB	00	00000000	0	
6A	VSO	00	00000000	0	
6B	VS	00	00000000	0	
6C	Detail Timing Description #4	00	00000000	0	
6D	Flag	00	00000000	0	
6E	Reserved	00	00000000	0	
6F	For Brightness Table and Power Consumption	02	00000010	2	
70	Flag	00	00000000	0	Header
71	PWM % [7:0] @ Step 0	10	00010000	16	
72	PWM % [7:0] @ Step 5	48	01001000	72	
73	PWM % [7:0] @ Step 10	FF	111111111	255	
74	Nits [7:0] @ Step 0	OF	00001111	15	
75	Nits [7:0] @ Step 5	3C	00111100	60	
76	Nits [7:0] @ Step 10	6E	01101110	110	Brightness Table
77	Panel Electronics Power @ 32x32 Chess Pattern =	1E	00011110	30	
78	Backlight Power @ 60 nits =	15	00010101	21	
79	Backlight Power @ Step 10 =	27	00100111	39	Power
7A	Nits @ 100% PWM Duty =	6E	01101110	110	Consumption
7B	Flag	20	00100000	32	
7C	Flag	20	00100000	32	
7D	Flag	20	00100000	32	
7E	Extension Flag	00	00000000	0	
<b>7F</b>	Checksum	5F	01011111	95	